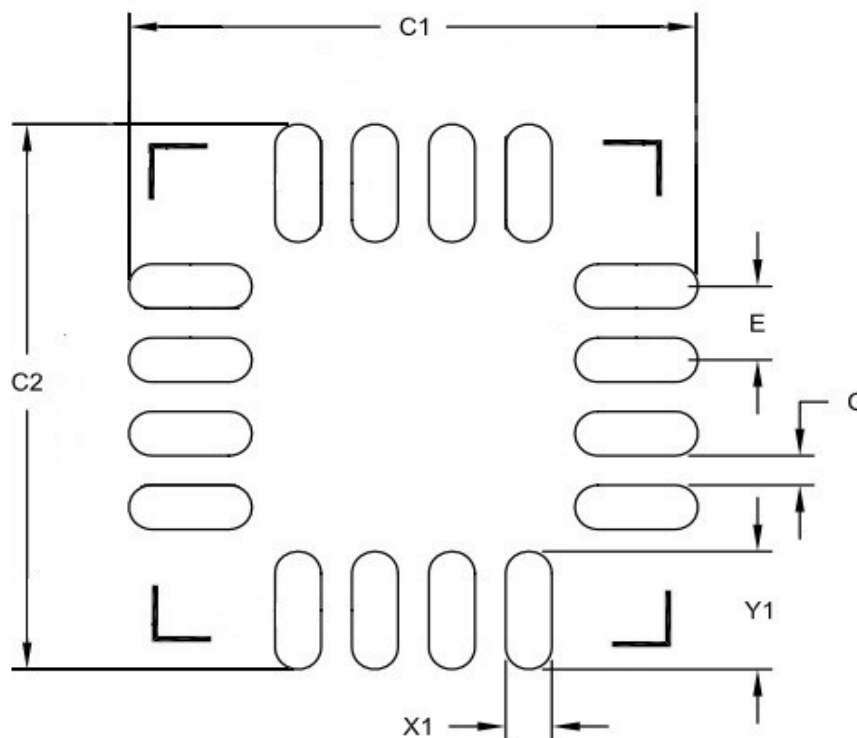


MLF32 5x5mm 0.5mm - stencil

Units		MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E		0.50	
Contact Pad Spacing	C1,C2		5.30	
Contact Pad Width	X1		0.22	
Contact Pad Length	Y1		0.60	
Distance Between Pads	G		0.28	

Top View (SMD Footprint)



Stencil dimensions: 38mm x 28mm

Thickness: 100-127 μ m

Material: stainless steel or nickel silver

Manufacturing processes: lasering or chemical etching

Datasheet rev.: 1.04